# Fast Diode Phase-Leg Power Module



**APTDF300A120D16AG** 

### **Product Overview**

The APTDF300A120D16AG device is a 1200V, 300A fast diode phase-leg power module. The following figures show the electrical diagram and pinout location of the device.

#### Figure 1. Electrical Diagram

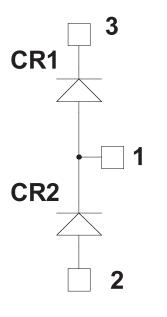
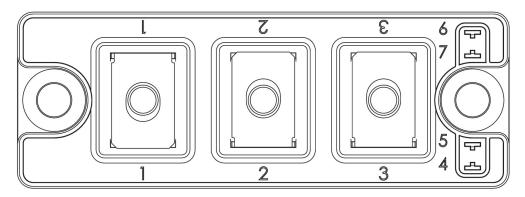


Figure 2. Pinout Location



**Note:** All ratings are at  $T_I = 25 \text{ °C}$ , unless otherwise specified.

These devices are sensitive to electrostatic discharge. Proper handling procedures must be followed. 

### Features

The APTDF300A120D16AG device has the following key features:

- Fast-recovery times
- Soft-recovery characteristics
- High-blocking voltage
- High current
- Low-leakage current
- M6 power connectors
- Aluminum Nitride (AIN) substrate for improved thermal performance

# **Benefits**

The APTDF300A120D16AG device has the following benefits:

- Outstanding performance at high-frequency operation
- Low losses
- Low-noise switching
- Direct mounting to heatsink (isolated package)
- Low junction-to-case thermal resistance
- RoHS Compliant

# Application

The APTDF300A120D16AG device has the following applications:

- Uninterruptible Power Supply (UPS)
- Induction heating
- Welding equipment
- High-speed rectifiers



## 1. Electrical Specification

The following sections describe the electrical specifications of the APTDF300A120D16AG device.

### **1.1** Diode Characteristics (Per Diode)

The following table lists the absolute maximum ratings of the APTDF300A120D16AG device.

Symbol	Parameter			Maximum Ratings	Unit
V <sub>RRM</sub>	Peak repetitive reverse voltage			1200	V
IF	DC forward current		T <sub>C</sub> = 25 °C	600	А
			T <sub>C</sub> = 110 °C	300	
I <sub>FSM</sub>	Non-repetitive forward surge current	t <sub>P</sub> = 8.3 ms	T <sub>C</sub> = 45 °C	1500	
I <sub>FRM</sub>	Repetitive forward current	t <sub>P</sub> = 1 ms	—	600	

#### Table 1-1. Absolute Maximum Ratings

The following table lists the electrical characteristics of the APTDF300A120D16AG device.

#### Table 1-2. Electrical Characteristics

Symbol	Characteristic	Test Conditions		Min.	Тур.	Max.	Unit
V <sub>F</sub>	Diode forward voltage	I <sub>F</sub> = 300A		—	2.4	3.5	V
		I <sub>F</sub> = 450A		—	2.7	—	
		I <sub>F</sub> = 300A	T <sub>J</sub> = 125 °C	_	1.8	—	
I <sub>RRM</sub>	Reverse leakage current	V <sub>R</sub> = 1200V		—	—	300	μA
C <sub>T</sub>	Junction capacitance	V <sub>R</sub> = 200V		_	330	—	pF

The following table lists the dynamic characteristics of the APTDF300A120D16AG device.

Table 1-3. Dyn	amic Characteristics
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Symbol	Characteristic	Test Conditions		Min.	Тур.	Max.	Unit
t <sub>rr</sub>	Reverse recovery time	I <sub>F</sub> = 300A	T <sub>J</sub> = 25 °C	_	385	-	ns
		V <sub>R</sub> = 800V	T <sub>J</sub> = 125 °C	—	480	—	
Q <sub>rr</sub>	Reverse recovery charge	di/dt = 600 A/µs	T <sub>J</sub> = 25 °C		3.16	—	μC
			T <sub>J</sub> = 125 °C	—	15.7	_	
I <sub>rm</sub>	m Reverse recovery current		T <sub>J</sub> = 25 °C	—	18	—	А
			T <sub>J</sub> = 125 °C	—	57	—	
t <sub>rr</sub>	Reverse recovery time	I <sub>F</sub> = 300A	T <sub>J</sub> = 125 °C	_	210	—	ns
Q <sub>rr</sub>	Reverse recovery charge	V <sub>R</sub> = 800V		—	28	—	μC
I <sub>rm</sub>	Reverse recovery current	di/dt = 3000 A/µs		_	210	—	А
R <sub>thJC</sub>	Junction-to-case thermal resis	stance		_	—	0.094	°C/W



### **1.2** Thermal and Package Characteristics

The following table lists the thermal and package characteristics of the APTDF300A120D16AG device.

Symbol	Characteristic	Characteristic		Min.	Max.	Unit
V <sub>ISOL</sub>	RMS isolation voltage, any terminal to case,	RMS isolation voltage, any terminal to case, t = 1 min, 50/60Hz		4000	-	V
Tj	Operating junction temperature range	Operating junction temperature range		-40	175	°C
T <sub>JOP</sub>	Recommended junction temperature under	switching cond	itions	-40	T <sub>Jmax</sub> –25	
T <sub>STG</sub>	Storage temperature range			-40	125	
T <sub>C</sub>	Operating case temperature			-40	125	
Torque	Mounting torque	For terminals	M6	3	5	N.m
		To heatsink				
Wt	Package weight			-	160	g

 Table 1-4.
 Thermal and Package Characteristics



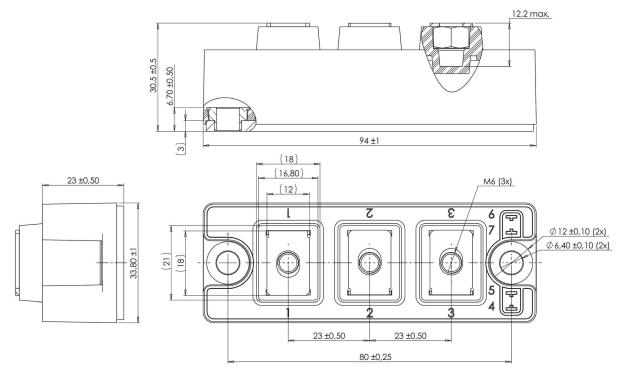
### 2. Package Specifications

The following section describes the package specification of the APTDF300A120D16AG device.

### 2.1 Package Outline

The following figure shows the package outline drawing of the APTDF300A120D16AG device. The dimensions in the following figure are in millimeters.

#### Figure 2-1. Package Outline Drawing





# 3. Typical Performance Curve

The following figures show the performance curves of the APTDF300A120D16AG device.

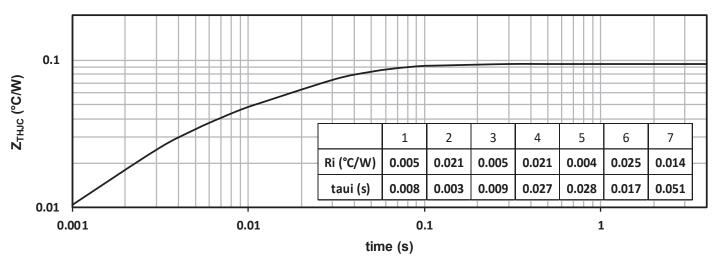
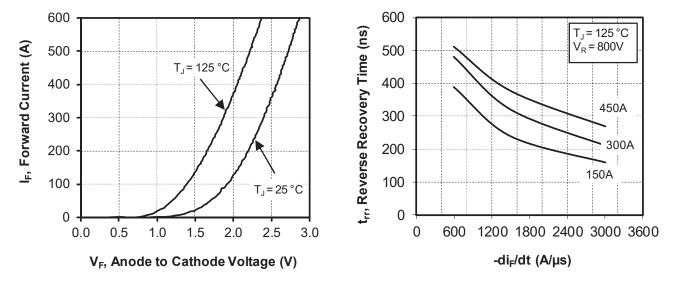






Figure 3-3. trr vs. Current Rate of Charge





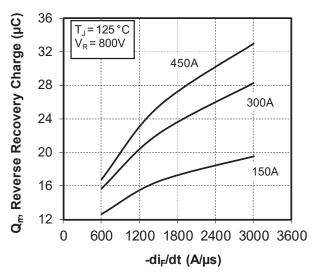
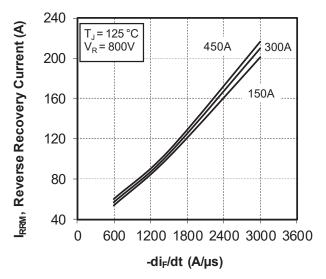


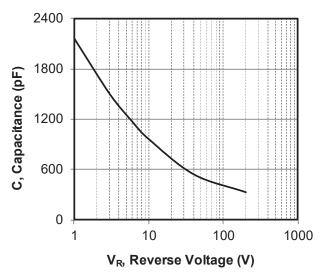
Figure 3-4. Q<sub>rr</sub> vs. Current Rate Charge

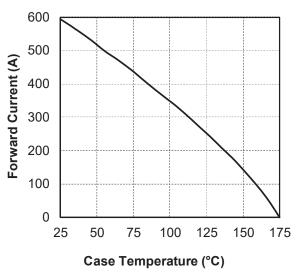
Figure 3-5.  $I_{RRM}$  vs. Current Rate of Charge













## 4. Revision History

The revision history describes the changes that were implemented in the document. The changes are listed by revision, starting with the most current publication.

Revision	Date	Description
A	01/2024	Initial revision



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